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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of: Fukutomi et al.

Serial No.: to be assigned

Group Art Unit: 2812

Filed: Concurrently filed

For: FABRICATION PROCESS OF

SEMICONDUCTOR PACKAGE AND SEMICONDUCTOR PACKAGE



New York, NY January 8, 2002

Examiner: to be assigned

Attorney Docket No.: 7426-082

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents Washington, D.C. 20231

Sir:

In accordance with the duty of disclosure provisions of 37 C.F.R. §1.56, there is hereby provided certain information which the Examiner may consider material to the examination of the subject U.S. patent application. It is requested that the Examiner make this information of record if it is deemed material to the examination of the application.

- Enclosures accompanying this Information Disclosure Statement are:
 - la. A list of all patents, publications, applications, or other information submitted for consideration by the office.
 - 1b. A legible copy of:
 - Each U.S. patent application publication and U.S. and foreign patent;
 - Each publication or that portion which caused it to be listed on the PTO-1449;
 - For each cited pending U.S. application, the application specification including the claims, and any drawing of the application, or portion of the application which caused it to be listed on the PTO-1449 including any claims directed to that portion;
 - all other information or portion which caused it to be listed on the PTO-1449.

lc. An English language copy of search report(s) from a counterpart foreign application or PCT International Search Report. 1d. Explanations of relevancy (ATTACHMENT 1(d), hereto) or English language abstracts of the non-English language publications. This Information Disclosure Statement is filed under 37 C.F.R. §1.97(b): Within three months of the filing date of a national application other than a continued prosecution application under §1.53(d); □ Within three months of the date of entry of the national stage as set forth in §1.491 in an international application; □ Before the mailing of the first Office action on the merits: □ Before the mailing of a first Office action after the filing of a request for continued examination under §1.114. ☐ This Information Disclosure Statement is filed under 37 C.F.R. §1.97(c) after the period specified in 37 C.F.R §1.97(b), but before the mailing date of any of a final action under 37 C.F.R. §1.113, a notice of allowance under 37 C.F.R. §1.311 or an action that otherwise closes prosecution in the application. (Check either Item 3a or 3b) The Certification Statement in Item 5 below is applicable. Accordingly, no fee is 3a. required. The \$180.00 fee set forth in 37 C.F.R. §1.17(p) in accordance with 37 C.F.R. 3b. §1.97(c) is: □ enclosed to be charged to Pennie & Edmonds LLP Deposit Account No. 16-1150. (Item 3b to be checked if any reference known for more than 3 months) 4.

This Information Disclosure Statement is filed under 37 C.F.R. §1.97(d) after the period specified in 37 C.F.R. §1.97(c), but on or before the date of payment of the issue fee. The \$180.00 fee set forth in 37 C.F.R. §1.17(p) is: □ to be charged to Pennie & Edmonds LLP Deposit Account No. 16-1150. The Certification Statement in Item 5 below is applicable. (Check either Item 5a or 5b)

□ In accordance with 37 C.F.R. §1.97(e)(1), it is certified that each item of information

contained in this Information Disclosure Statement was first cited in a

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5a.

- communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.
- 5b.

 In accordance with 37 C.F.R. §1.97(e)(2), it is certified that no item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application and, to the knowledge of the undersigned after making reasonable inquiry, was known by any individual designated in 37 C.F.R. §1.56(c) more than three months prior to the filing of this Information Disclosure Statement.
- 6.
 ☐ This application is a continuation application under 37 C.F.R. §1.60 or §1.53(b) or (d).

(Check appropriate Items 6a, 6b and/or 6c)

- 6a.

 A Petition to Withdraw from issue under 37 C.F.R. §1.313(b)(5) is concurrently filed herewith.
- 6b. ⊠ Copies of publications listed on Form PTO-1449 from prior applications Serial Nos. 08/716,362, 09/326,316, and 09/478,682, filed on September 18, 1996, June 7, 1999 and January 19, 2000, respectively, of which this application claims priority under 35 U.S.C. §120, are not being submitted pursuant to 37 C.F.R. §1.98(d).
- 6c. Copies of the publications listed on Form PTO-1449 were not previously cited in prior application Serial No., filed on, and are provided herewith.
- 7.

 This is a Supplemental Information Disclosure Statement. (Check either Item 7a or 7b)
 - 7a.

 This Supplemental Information Disclosure Statement under 37 C.F.R. §1.97(f) supplements the Information Disclosure Statement filed on ___. A bona fide attempt was made to comply with 37 C.F.R. §1.98, but inadvertent omissions were made. These omissions have been corrected herein. Accordingly, additional time is requested so that this Supplemental Information Disclosure Statement can be considered as if properly filed on ___.
 - 7b.

 This Supplemental Information Disclosure Statement is timely filed within one (1) month of a PTO Notice under 37 C.F.R. §1.97(i).
- 8.
 In accordance with 37 C.F.R. §1.98, a concise explanation of what is presently understood to be the relevance of each non-English language publication is:

(Check Item 8a, 8b, or 8c)

- 8a.

 satisfied because all non-English language publications were cited on the enclosed English language copy of the PCT International Search Report or the search report from a counterpart foreign application indicating the degree of relevance found by the foreign office.
- 8b. \Box set forth in the application.

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- 9.
 ☐ The Commissioner is authorized to charge any additional fee required or credit any overpayment for this Information Disclosure Statement and/or Petition to Pennie & Edmonds LLP Deposit Account No. 16-1150.
- 10.

 No admission is made that the information cited in this Statement is, or is considered to be, material to patentability nor a representation that a search has been made (other than a search report of a foreign counterpart application or PCT International Search Report if submitted herewith). 37 C.F.R. §§1.97(g) and (h).

Respectfully submitted,

Date January 8, 2002

24,576

(Reg. No.)

Charles E. Miller PENNIE & EDMONDS LLP 1155 Avenue of Americas New York NY 10036-2720 (212) 790 - 9090

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Application No. 09/326,316 Applicant(s)

Fukutomi et al.

Examiner

Luan Thai

Group Art Unit 2811

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Examiner

Josetta I. Jones

Applicant(s)/Patent Under
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ATTY. DOCKET NO. 7426-065 LIST OF REFERENCES CITED BY APPLICANT APPLICANT (Use several sheets if necessary) Fukutomi et al. FILING DATE GROUF June 7, 1999 **U.S. PATENT DOCUMENTS** DOCUMENT NUMBER DATE aass SUBCLASS FILING DATE APPROPRIATE LT AΑ 5,467,252 11/1995 Nomi et al. 361 760 LT AB 4,688,150 8/1987 Peterson 361 403 LT AC 3,878,555 4/1975 Freitag et al. 257 668 LT AD 4,376,287 3/1983 257 Sechi 668 LI ΑE 3,748,543 7/1973 Roberson 257 778 LT AF 5,381,039 1/1995 Morrison 257 778 LT AG 5,579,207 257 11/1996 Hayden et al. 778 **FOREIGN PATENT DOCUMENTS** DOCUMENT NUMBER SUBCLASS TRANSLATION YES NO LT AΗ EP 0391790 A1 10/10/90 Europe LT ΑI WO92/21150 11/26/92 **PCT** LT EP 0 091 072 A 10/12/83 Europe LT ΑK JP 5-129473 5/25/93 Japan LT ΑL JP 3-94459 4/19/91 Japan LT AM 59-208756 11/27/84 Japan OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, Etc.) Matsuo et al., "Smallest Flip-Chip-Like Package 'Chip Scale Package (CSP)", The Second VLS Packaging AN LT

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1. ivan Thai

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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